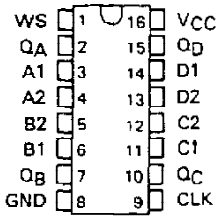
SN54LS399, SN74LS399
QUADRUPLE 2-INPUT MULTIPLEXERS WITH STORAGE

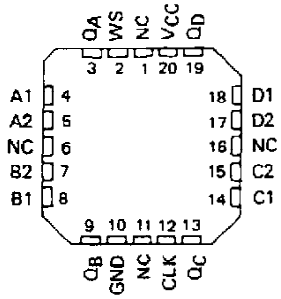
SDLS174 OCTOBER 1976 – REVISED MARCH 1988

- **Single-Rail Outputs on 'LS399**
- **Selects One of Two 4-Bit Data Sources and Stores Data Synchronously with System Clock**
- **Applications:**
  - **Dual Source for Operands and Constants in Arithmetic Processor; Can Release Processor Register Files for Acquiring New Data**
  - **Implement Separate Registers Capable of Parallel Exchange of Contents Yet Retain External Load Capability**
  - **Universal Type Register for Implementing Various Shift Patterns: Even Has Compound Left-Right Capabilities**

SN54LS399 . . . J OR W PACKAGE
SN74LS399 . . . D OR N PACKAGE
(TOP VIEW)



SN54LS399 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description

This monolithic quadruple two-input multiplexer with storage provides essentially the equivalent functional capabilities of two separate MSI functions (SN54LS157/SN74LS157 and SN54LS175/SN74LS175) in a single 16-pin package.

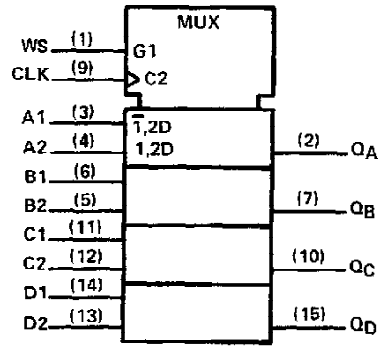
When the word-select input is low, word 1 (A1, B1, C1, D1) is applied to the flip-flops. A high input to word select will cause the selection of word 2 (A2, B2, C2, D2). The selected word is clocked to the output terminals on the positive-going edge of the clock pulse.

Typical power dissipation is 37 milliwatts. The SN54LS399 is characterized for operation over the full military range of −55°C to 125°C. The SN74LS399 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE

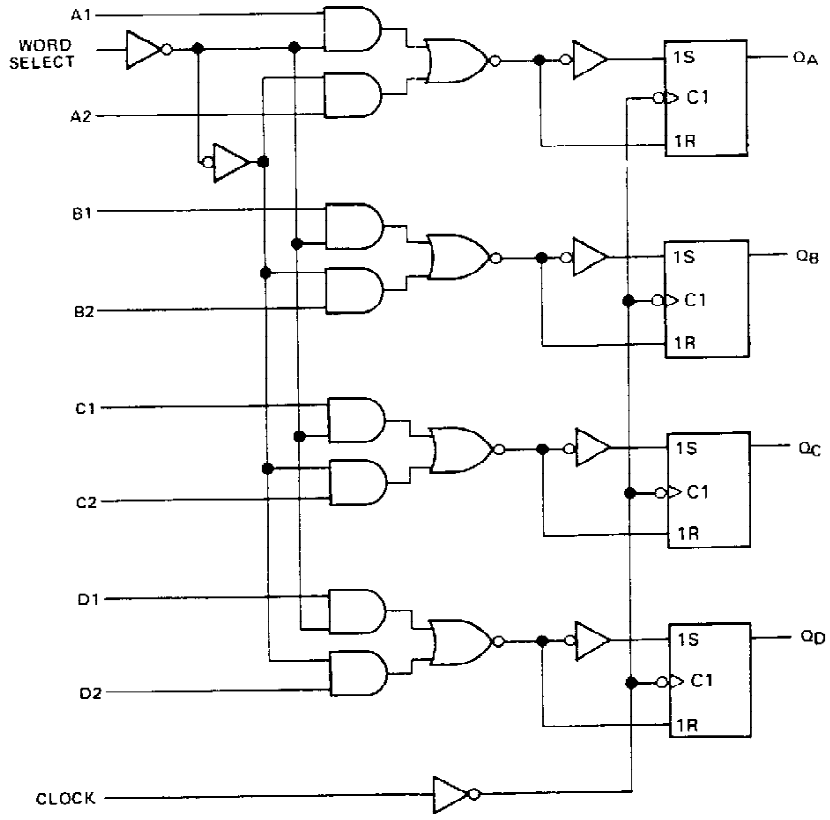
INPUTS		OUTPUTS			
WORD SELECT	CLOCK	Q_A	Q_B	Q_C	Q_D
L	↑	a1	b1	c1	d1
H	↑	a2	b2	c2	d2
X	L	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}

logic symbol†

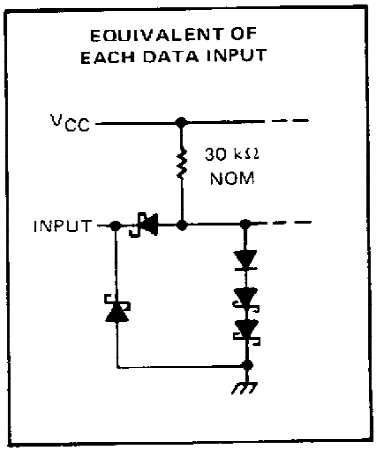


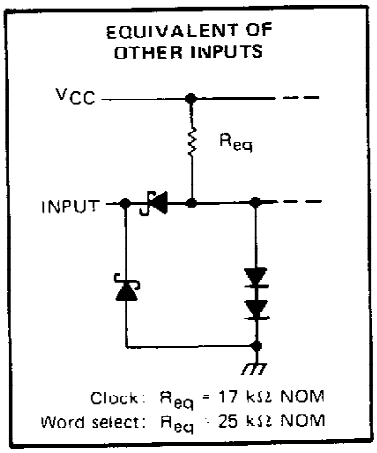
†This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, N, and W packages.

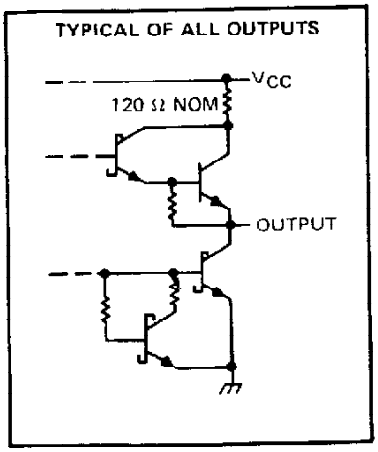
logic diagram (positive logic)



schematics of inputs and outputs







absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 7 V
Operating free-air temperature range: SN54LS399 . . . . . −55°C to 125°C
SN74LS399 . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminals.

recommended operating conditions

		SN54LS399			SN74LS399			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}				−400			−400	μA
Low-level output current, I_{OL}				4			8	mA
Width of clock pulse, high or low level, t_w		20			20			ns
Setup time, t_{su}	Data	25			25			ns
	Word select	45			45			
Hold time, t_h	Data	0			0			ns
	Word select	0			0			
Operating free-air temperature, T_A		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†			SN54LS399			SN74LS399			UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage				2			2			V
V_{IL}	Low-level input voltage						0.7			0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN,	I_I = −18 mA				−1.5			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IL} = V_{IL}max	V_{IH} = 2 V, I_{OH} = −400 μA		2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IL} = V_{IL}max	V_{IH} = 2 V,	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
				I_{OL} = 8 mA					0.35	0.5	
I_I	Input current at maximum input voltage	V_{CC} = MAX,	V_I = 7 V				0.1			0.1	mA
I_{IH}	High-level input current	V_{CC} = MAX,	V_I = 2.7 V				20			20	μA
I_{IL}	Low-level input current	V_{CC} = MAX,	V_I = 0.4 V				−0.4			−0.4	mA
I_{OS}	Short-circuit output current§	V_{CC} = MAX			−20		−100	−20		−100	mA
I_{CC}	Supply current	V_{CC} = MAX,	See Note 2			7.3	13		7.3	13	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, duration of the short-circuit should not exceed one second.
NOTE 2: With all outputs open and all inputs except clock low, I_{CC} is measured after applying a momentary 4.5 V, followed by ground, to the clock input.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output	C_L = 15 pF, R_L = 2 kΩ, See Note 3		18	27	ns
t_{PHL}	Propagation delay time, high-to-low-level output			21	32	

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

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